

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

Chopra et al.

**Serial No.:** 10/620,002

**Filed:** July 14, 2003

**For:** SLURRY FOR USE WITH FIXED-  
ABRASIVE POLISHING PADS IN  
POLISHING SEMICONDUCTOR DEVICE  
CONDUCTIVE STRUCTURES THAT  
INCLUDE COPPER AND A COPPER  
BARRIER (as amended)

**Confirmation No.:** 7481

**Examiner:** L. Vinh

**Group Art Unit:** 1792

**Attorney Docket No.:** 2269-4373.2US  
(2000-0036.02/US)

VIA ELECTRONIC FILING

November 5, 2008

**AMENDMENT**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Examiner:

This Amendment follows the Office Action of August 5, 2008, the shortened statutory period for response to which expires on November 5, 2008.

A listing of claims, in which revisions to the claims are presented, begins on page 2 of this paper; and

Remarks start at page 6 of this paper.